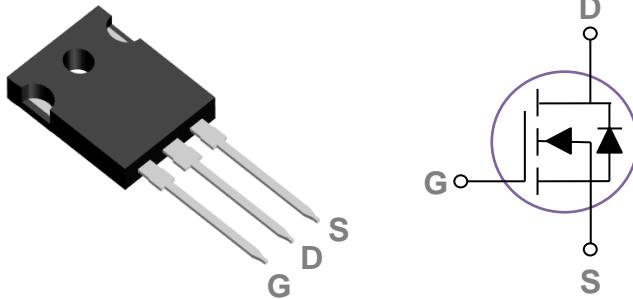


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO247 Pin Configuration



BVDSS	RDS(ON)	ID
60V	3.2mΩ	175A

### Features

- 60V, 175A, RDS(ON) = 3.2mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
V <sub>Gs</sub>	Gate-Source Voltage	+20/-12	V
I <sub>D</sub>	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	175	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	110	A
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	700	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	245	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	70	A
P <sub>D</sub>	Power Dissipation ( $T_c=25^\circ\text{C}$ )	192	W
	Power Dissipation – Derate above 25°C	1.54	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	---	62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction to Case	---	0.65	°C/W

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	60	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25\text{ }^{\circ}\text{C}$ , $I_D=1\text{mA}$	---	0.05	---	$\text{V}/^{\circ}\text{C}$
$I_{DS}$	Drain-Source Leakage Current	$V_{DS}=60\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	$\mu\text{A}$
		$V_{DS}=48\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=85\text{ }^{\circ}\text{C}$	---	---	10	$\mu\text{A}$
$I_{GS}$	Gate-Source Leakage Current	$V_{GS}=20\text{V}$ , $V_{DS}=0\text{V}$	---	---	100	$\text{nA}$

**On Characteristics**

$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$ , $I_D=20\text{A}$	---	2.6	3.2	$\text{m}\Omega$
		$V_{GS}=6\text{V}$ , $I_D=10\text{A}$	---	3.4	4.5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}$ , $I_D=10\text{A}$	---	4.8	7.0	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D = 250\mu\text{A}$	1.2	1.6	2.5	V
$\Delta V_{GS(\text{th})}$	$V_{GS(\text{th})}$ Temperature Coefficient		---	-5	---	$\text{mV}/^{\circ}\text{C}$
$g_{fs}$	Forward Transconductance	$V_{DS}=10\text{V}$ , $I_D=5\text{A}$	---	15	---	S

**Dynamic and switching Characteristics**

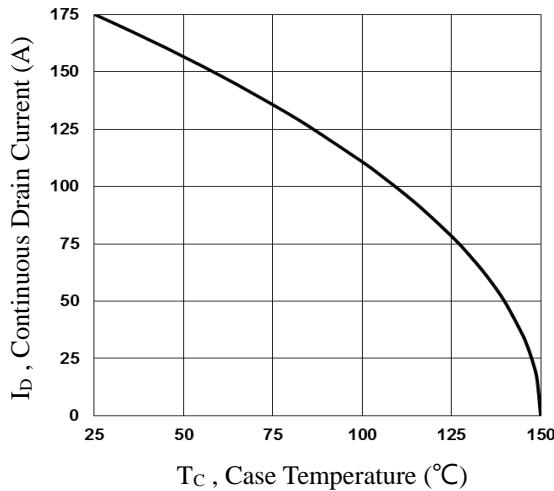
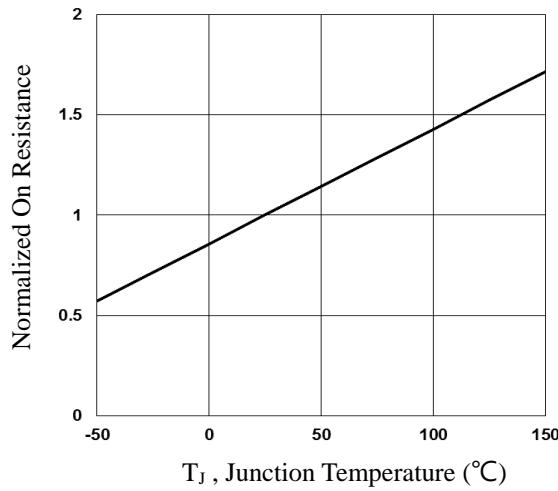
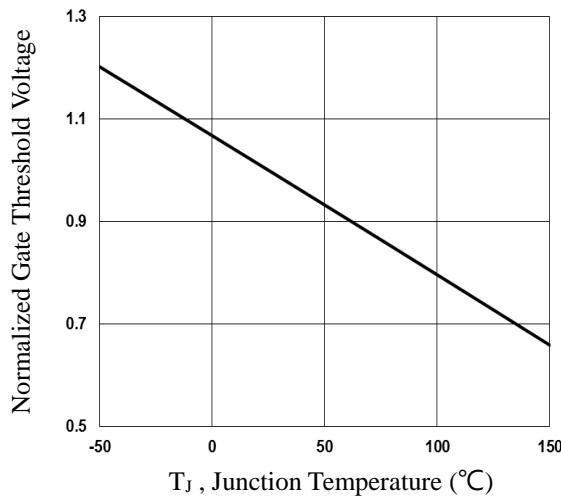
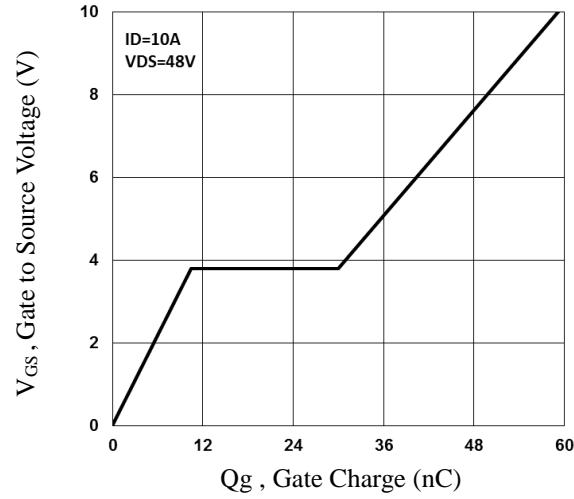
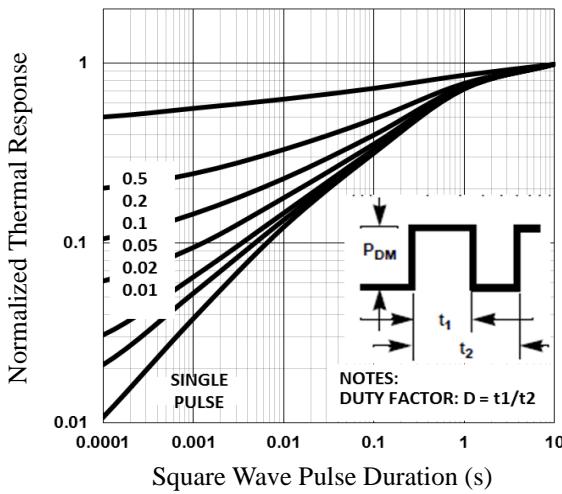
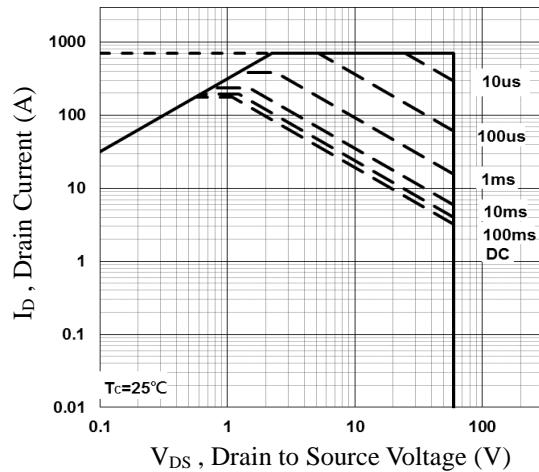
$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{DS}=48\text{V}$ , $V_{GS}=10\text{V}$ , $I_D=10\text{A}$	---	59	120	nC
$Q_{gs}$	Gate-Source Charge <sup>3, 4</sup>		---	10.4	20	
$Q_{gd}$	Gate-Drain Charge <sup>3, 4</sup>		---	19.6	38	
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{DD}=30\text{V}$ , $V_{GS}=10\text{V}$ , $R_G=6\Omega$ $I_D=1\text{A}$	---	22	44	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	14	28	
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>		---	40	80	
$T_f$	Fall Time <sup>3, 4</sup>		---	20	40	
$C_{iss}$	Input Capacitance	$V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ , $F=1\text{MHz}$	---	3620	7200	pF
$C_{oss}$	Output Capacitance		---	2395	4800	
$C_{rss}$	Reverse Transfer Capacitance		---	177	350	
$R_g$	Gate resistance	$V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $F=1\text{MHz}$	---	1.8	3.6	$\Omega$

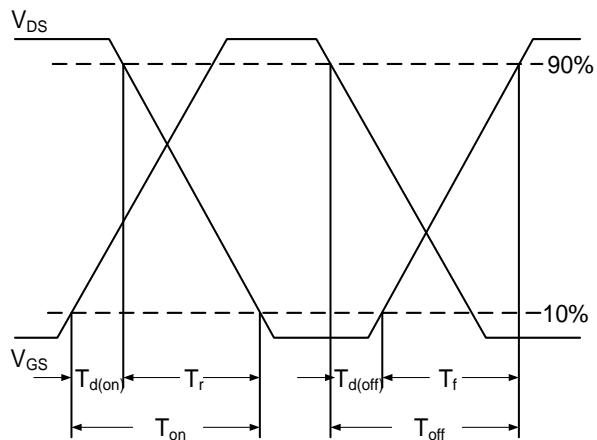
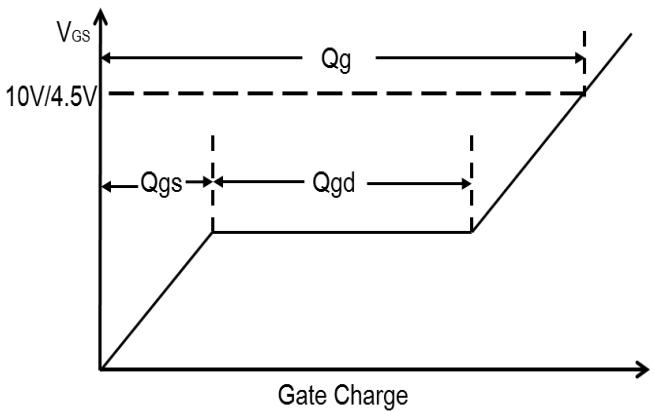
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	175	A
$I_{SM}$	Pulsed Source Current		---	---	350	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	V

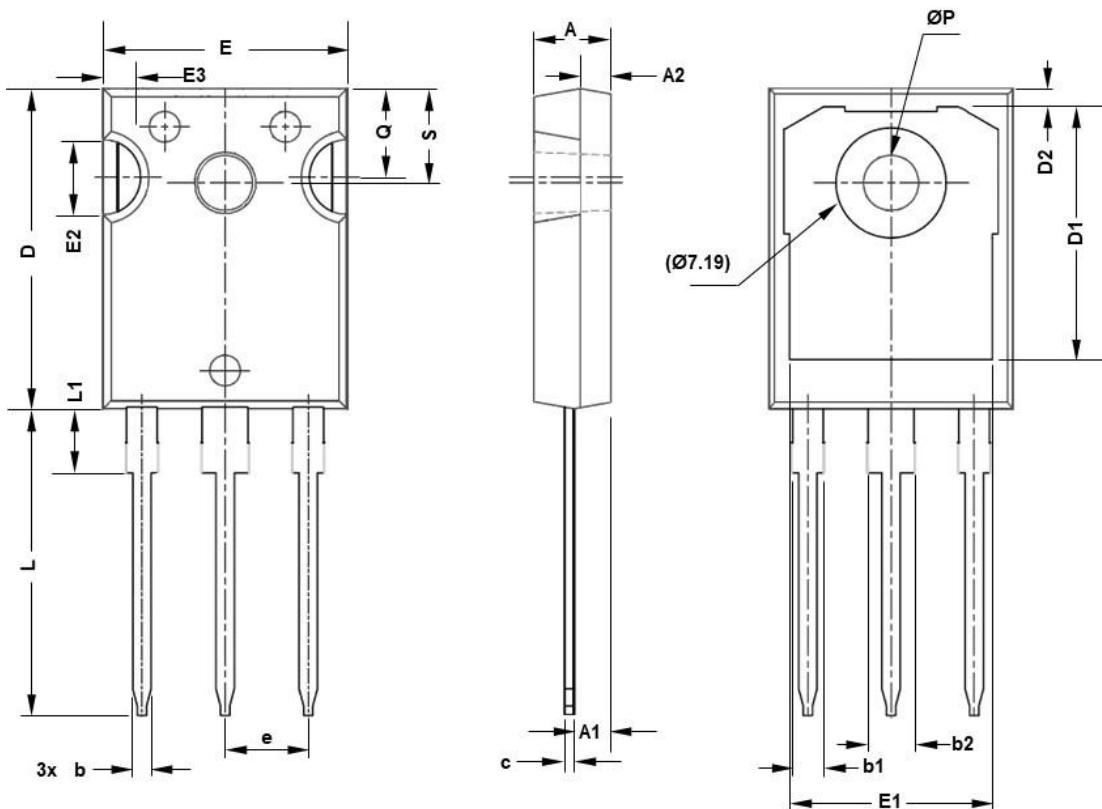
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=70\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25\text{ }^{\circ}\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs. Tc**

**Fig.2 Normalized RDSON vs. Tj**

**Fig.3 Normalized Vth vs. Tj**

**Fig.4 Gate Charge Characteristics**

**Fig.5 Normalized Transient Impedance**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 Gate Charge Waveform**

## TO247 PACKAGE INFORMATION



SYMBOL	mm		SYMBOL	mm	
	MIN	MAX		MIN	MAX
A	4.83	5.21	E2	4.32	5.49
A1	2.29	2.55	E3	2.15	2.80
A2	1.50	2.49	e	5.44BSC	
b	1.12	1.33	L	19.81	20.32
b1	1.91	2.39	L1	4.10	4.40
b2	2.87	3.22	ØP	3.56	3.65
C	0.55	0.69	Q	5.39	6.20
D	20.80	21.10	S	6.04	6.30
D1	16.25	17.65			
D2	0.51	1.35			
E	15.75	16.13			
E1	13.46	14.16			